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What Are Embedded - Microcontrollers - Application Specific?

Application-specific microcontrollers are engineered to

Details	
Product Status	Obsolete
Applications	Engine Control
Core Processor	S12XS
Program Memory Type	FLASH (256kB)
Controller Series	HCS12
RAM Size	12K x 8
Interface	CAN, SCI, SPI
Number of I/O	6
Voltage - Supply	4.7V ~ 36V
Operating Temperature	-40°C ~ 125°C
Mounting Type	Surface Mount
Package / Case	100-LQFP Exposed Pad
Supplier Device Package	100-LQFP-EP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mm912ks812amafr2

Document Number: MM912_S812
Rev. 2.0, 8/2016

S12XS MCU and multifunctional ignition and injector driver system in package (SiP)

912_S812

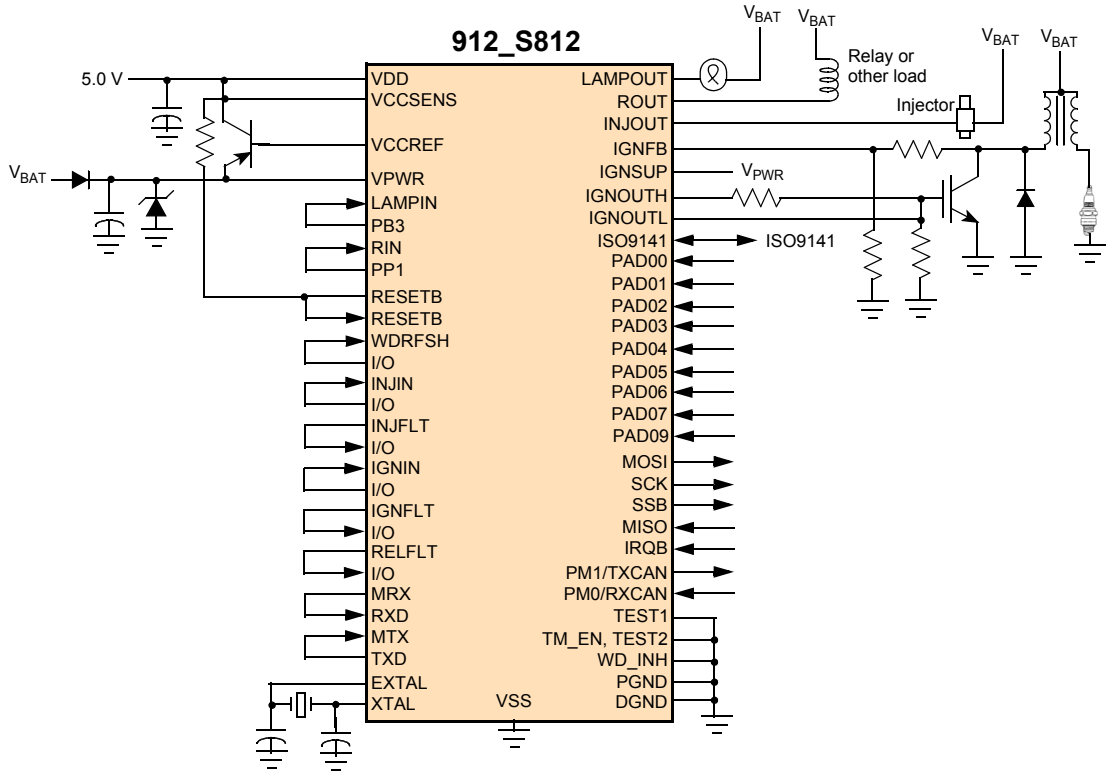
SMALL ENGINE CONTROL SIP

AF Suffix (Pb Free)
98ASA00371D
100 Pin LQFP-EP

The MM912_S812 is an engine control SMARTMOS IC combining an MCU (S12XS) and analog control die (MC33812) intended for motorcycle and other single cylinder small engine control applications.The MCU S12XS has 8.0 KB or 12 KB RAM, and flash memory size of 128 KB or 256 KB. The S12XS family retains many of the features of the S12XE family including error correction code (ECC) on flash memory, a separate data-flash module for code or data storage, a frequency modulated locked loop (IPLL) that improves the EMC performance and a fast ATD converter.

Features:

- Designed to operate over the range of ~4.7 V ≤ V_{PWR} ≤ 36 V
- Relay/injector/fuel pump driver – current limit – 4.0 A, typical
- Lamp driver – current limit – 1.5 A, typical
- All external outputs protected against short to battery and overcurrent
- VCC voltage pre-regulator provides +5.0 V power for the MCU
- MCU watchdog timer circuit with parallel refresh/time setting line
- ISO-9141 K-Line transceiver for communicating diagnostic messages



Notes
1. Surge Voltage protection recommended on VPWR
2. Not all connections on MCU shown

Figure 1. 912_S812 simplified application diagram

* This document contains certain information on a new product.
Specifications and information herein are subject to change without notice.

1 Orderable parts

This section describes the part numbers available to be purchased along with their differences. Valid orderable part numbers are provided on the web. To determine the orderable part numbers for this device, go to http://www.nxp.com and perform a part number search for the following device numbers.

Table 1. Orderable part variations

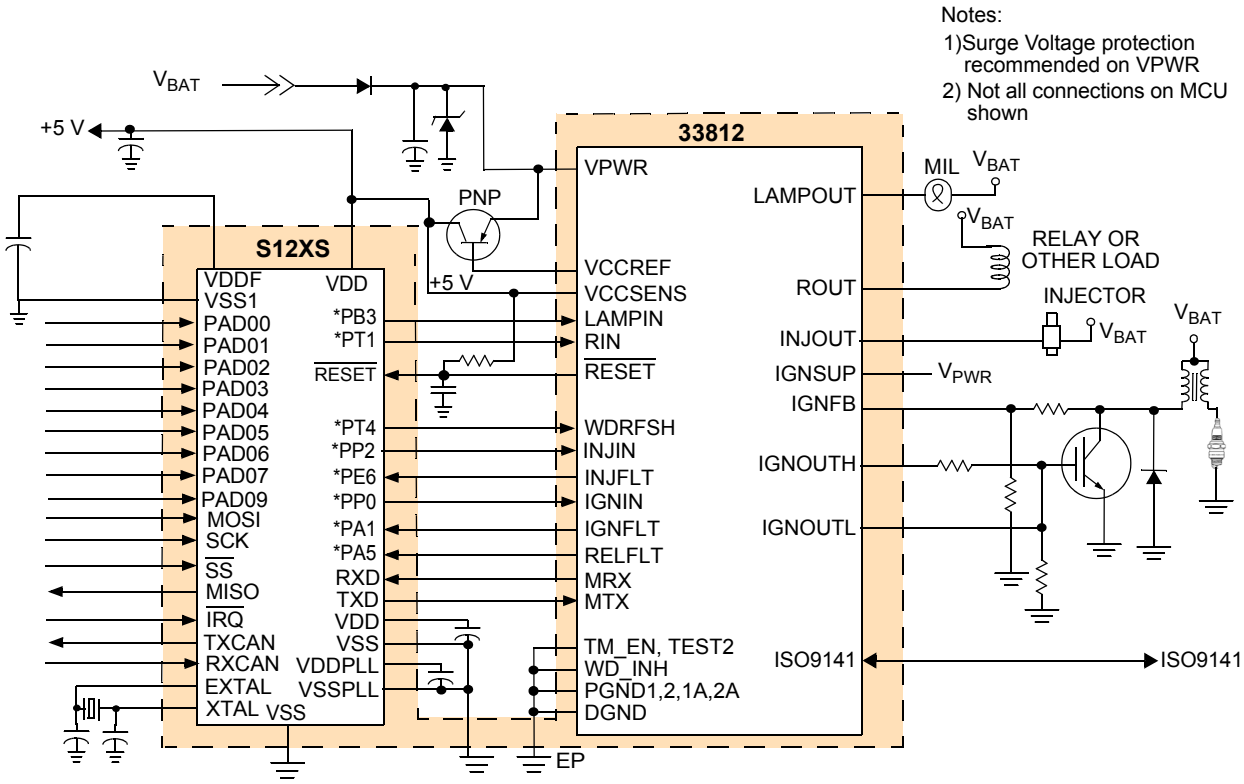
Part number [3]	MCU	Temperature (T_A)	Flash memory	RAM	Package
MM912JS812AMAF	S12XS	-40 to 125 °C	128 k	8.0 k	100 pin LQFP-EP
MM912KS812AMAF			256 k	12 k	

Notes

3. To Order parts in Tape & Reel, add the R2 suffix to the part number.

Table 2. Calibration tools

Part number		Package	
MC9S12XEP100 (MCU Only)	S12XEP	Multiple	Contact sales for availability and quantity
PV912NE812AMAF	S12XEP + MC33812	100 pin LQFP-EP	



* I/O pins indicated are examples only and not necessarily recommendations

Figure 2. 912_S812 detailed application diagram

2 Part identification

This section provides an explanation of the part numbers and their alpha numeric breakdown.

2.1 Description

Part numbers for the chips have fields that identify the specific part configuration. You can use the values of these fields to determine the specific part you have received.

2.2 Format and examples

Part numbers for a given device have the following format, followed by a device example:

Table 3 - Part numbering - analog EMBEDDED MCU + POWER:

MM 9 cc f xxx r v PPP RR - MM912JS812AMAF

2.3 Fields

These tables list the possible values for each field in the part number (not all combinations are valid).

Table 3. Part numbering - analog EMBEDDED MCU + POWER

FIELD	DESCRIPTION	VALUES
MM	Product Category	• MM- Qualified Device • SM- Custom Device • PM- Prototype Device
9	Memory Type	• 9 = Flash, OTP
cc	Micro Core	• 12 = HC12
f	Memory Size	• J 128 k • K 256 k
xxx	Analog Core/Target	• 812 - MC33812
r	Revision	• (default A)
t	Temperature Range	• M = -40 °C to 125 °C
v	Variation	• (default blank)
PPP	Package Designator	• AF - 100 lead LQFP with exposed pad
RR	Tape and Reel Indicator	• R2

3 Internal block diagram

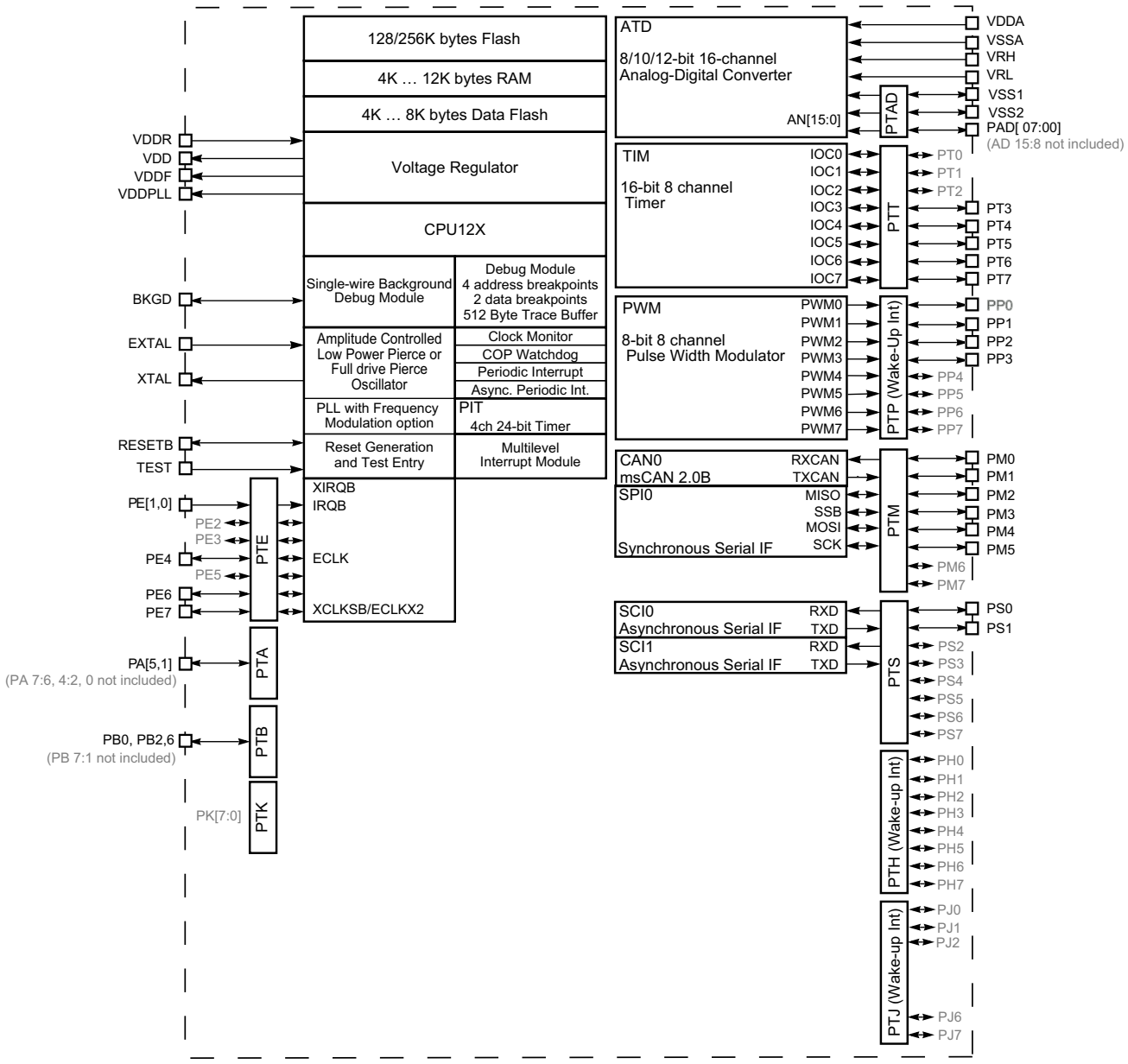
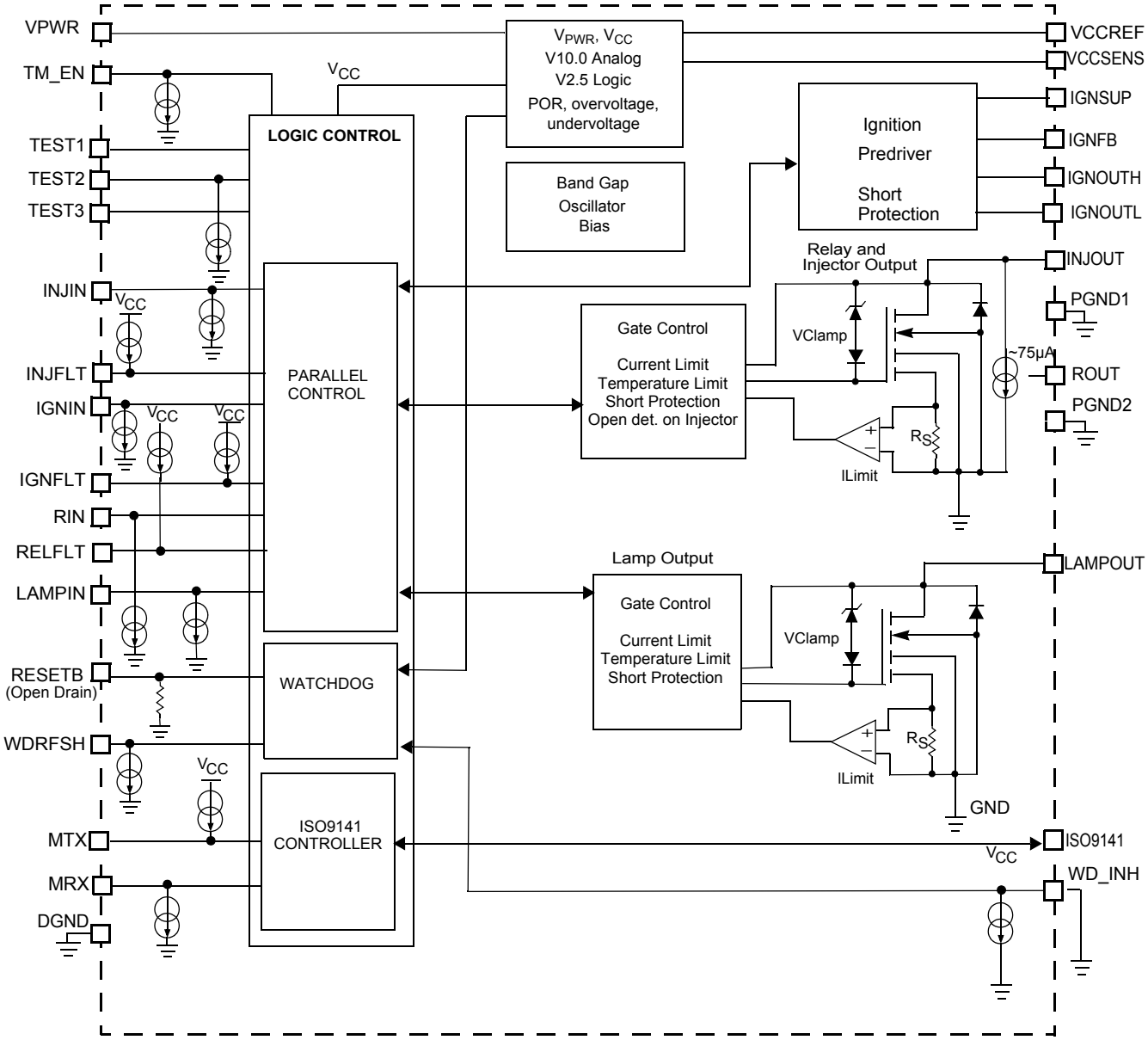


Figure 3. MC9S12XS family block diagram



Notes

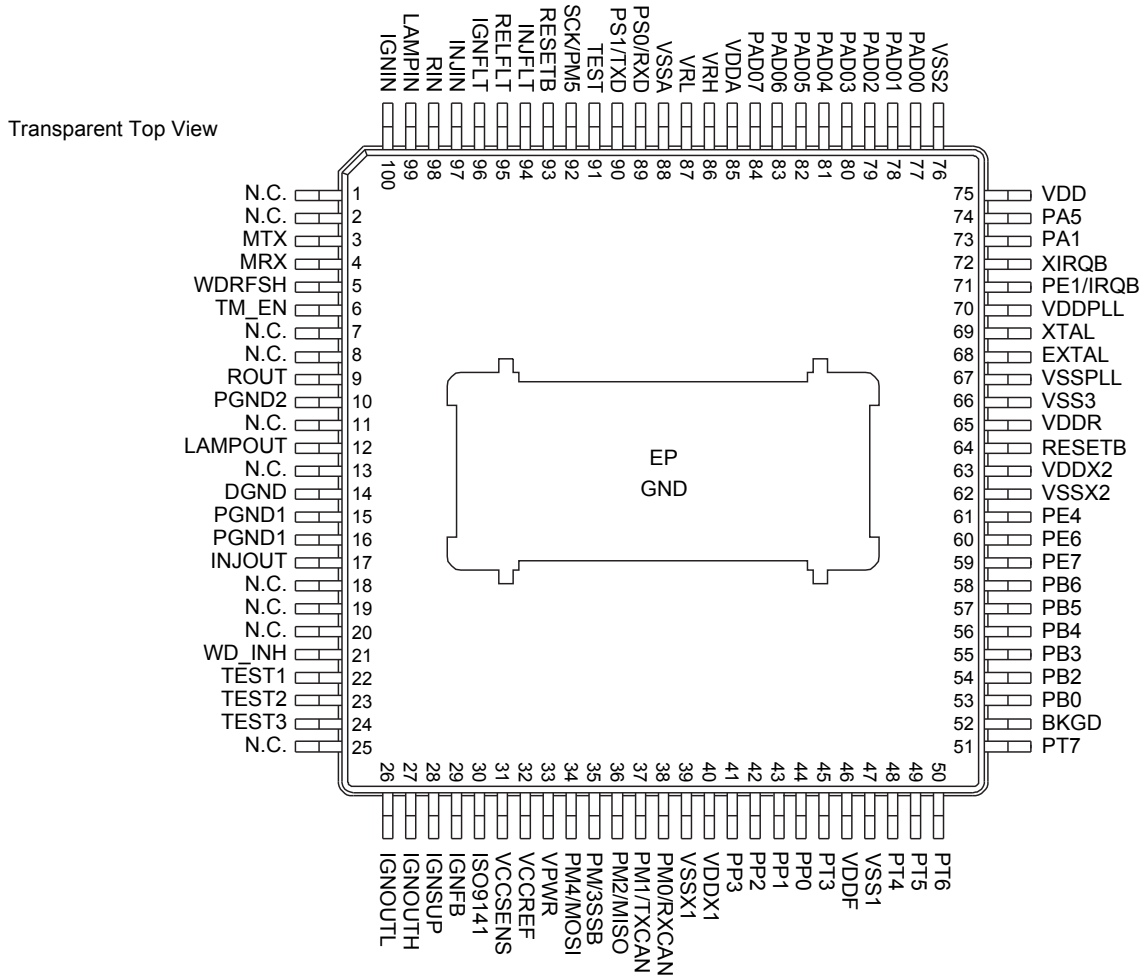
4. Pull-up and pull-down current sources are ~50 µA, unless otherwise noted

Figure 4. 33812 simplified internal block diagram

912_S812

4 Pin connections

4.1 Pinout diagram



Notes

5. EP, PGND1, PGND2, and DGND, must all be connected to the ground plane.
6. Compared to the MC33812 in the 32 pin SOICW package, there are no pins missing.
7. Compared to the S12XS in the 80 pin QFP package, 22 pins are missing in the SiP. These pins are: PB1, PB7, PE5, PJ2, PE2, PE3, PA0, PA2, PA3, PA4, PA6, PA7, PAD08, PAD09, PS2, PS3, PJ7, PJ6, PP7, PP6, PP5, and PP4.

Figure 5. 33812_S812 pin connections

4.2 Pin definitions

Table 4. 912_S812 pin definitions

Analog or MCU	Pin	Pin name	Pin function	Formal name	Description and recommendations
-	1	N.C.	Unused	-------	Unused pin, leave open
-	2	N.C.	Unused	-------	Unused pin, leave open
Analog	3	MTX	Input	ISO9141 Data Input to MCU	Input logic level ISO9141 data, from the MCU, to the ISO9141 IN/OUT pin Connect to MCU SCI TXD output (pin 90) if using ISO9141 circuit
Analog	4	MRX	Output	ISO9141 Data Output to MCU	Output logic level ISO9141 data to the MCU from the ISO9141 IN/OUT pin Connect to MCU SCI RXD input (pin 89) if using ISO9141 circuit
Analog	5	WDRFSH	Input	Watchdog Refresh	Logic Level input from MCU to refresh the watchdog circuit to prevent RESETB Connect to MCU I/O output (e.g. PT4 pin 48)
Analog	6	TM_EN	Input	Test Mode Enable	Used by NXP test engineering, Connect to Ground
-	7	N.C.	Unused	-------	Unused pin, leave open
-	8	N.C.	Unused	-------	Unused pin, leave open
Analog	9	ROUT	Output	Relay Driver Output	Low side relay driver output driven by parallel input RIN Use ESD capacitor where the signal goes off the PC Board.
Analog	10	PGND2	Ground	Power Ground 2	Ground for the RELAY driver output Connect to Ground
-	11	N.C.	Unused	-------	Unused pin, leave open
Analog	12	LAMPOUT	Output	Warning Lamp Output	Low side driver output for MIL (warning lamp) driven by parallel input LAMPIN. Use an ESD capacitor where the signal goes off the PC Board
-	13	N.C.	Unused	-------	Unused pin, leave open
Analog	14	DGND	Ground	Supply Ground	Used as ground for all low power signals. Connect to Ground
-	7	N.C.	Unused	-------	Unused pin, leave open
Analog	16	PGND1	Ground	Power Ground 1	Ground for INJOUT injector driver output. Connect to Ground
Analog	17	INJOUT	Output	Injector Driver Output	Low side driver output for the Injector driven by parallel input INJIN. Use an ESD capacitor where the signal goes off the PC Board.
-	7	N.C.	Unused	-------	Unused pin, leave open
-	19	N.C.	Unused	-------	Unused pin, leave open
-	20	N.C.	Unused	-------	Unused pin, leave open
Analog	21	WD_INH	Input	Watchdog Inhibit	Normally tied to GND, If tied high through a pull-up, it inhibits RESETB from occurring when a watchdog timeout occurs. Normally connect to Ground.
Analog	22	TEST1	Input	Test 1	MUST be tied to GND. Connect to Ground
Analog	23	TEST2	Input	Test 2	MUST be tied to GND. Connect to Ground
Analog	24	TEST3	Input	Test 3	MUST leave OPEN. Leave open
-	25	N.C.	Unused	-------	Unused pin. Leave open
Analog	26	IGNOUTL	Output	Ignition Output Low	Low side output to drive the Gate/Base of the IGBT/Bipolar Darlington The network used on this pin is determined by the user requirements.
Analog	27	IGNOUTH	Output	Ignition Output High	High side output to drive the Gate/Base of IGBT/Bipolar Darlington The network used on this pin is determined by the user requirements.
Analog	28	IGNSUP	Input	Ignition Output Supply	Tie to +5.0 V for Darlington, tie to the V_{PWR} supply for the IGBT output device
Analog	29	IGNFB	Input	Feedback from Source	Voltage feedback from the source of the Ignition driver transistor through a 10:1 voltage divider. Use a 10:1 voltage divider (36 k/4.02 k)

Table 4. 912_S812 pin definitions

Analog or MCU	Pin	Pin name	Pin function	Formal name	Description and recommendations
Analog	30	ISO9141	Input/ Output	ISO9141 K-Line Bidirectional Serial Data Signal	The ISO9141 pin is a V_{PWR} level IN/OUT signal connected to a external ECU Tester, using ISO9141 Protocol.The Output is Open drain and the Input is a ratiometric V_{PWR} level threshold comparator. Use an ESD capacitor where the signal goes off the PC Board.
Analog	31	VCCSENS	Input	Voltage Sense from VCC	Feedback to the internal VCC regulator from a external pass transistor. Must have the minimum of a 2.2 μF capacitor
Analog	32	VCCREF	Output	VCC Reference Base drive	Base drive voltage for an external PNP pass transistor
Analog	33	VPWR	Supply Input	Main Voltage Supply Input	VPWR is the main voltage supply input for the device. It is connected to a +12 volt battery (It should have reverse battery protection and transient suppression.) It also needs a bypass capacitor to ground (100 nF or 0.1 μF)
MCU	34	PM4/MOSI	I/O	PM4/ SPI MOSI	Port M, I/O pin 4 is a general purpose input or output pin. It can be configured as the master output (during master mode) or slave input pin (during slave mode). MOSI for the serial peripheral interface (SPI).
MCU	35	PM3/SSB	I/O	PM3/ SPI SSB	Port M, I/O pin 3 is a general purpose input or output pin. It can be configured as the slave select output pin SSB of the serial peripheral interface (SPI) (during master mode) and chip select input (CSB) (during slave mode).
MCU	36	PM2/MISO	I/O	PM2/ SPI MISO	Port M, I/O pin 2 is a general purpose input or output pin. It can be configured as the master input (during master mode) or slave output pin (during slave mode). MISO for the serial peripheral interface (SPI).
MCU	37	PM1/TXCAN	I/O	PM1/ TXCAN	Port M, I/O pin 1 is a general purpose input or output pin. It can be configured as the transmit pin TXCAN of the scalable controller area network controller (CAN).
MCU	38	PM0/RXCAN	I/O	PM0/ RXCAN	Port M, I/O pin 0 is a general purpose input or output pin. It can be configured as the receive pin RXCAN of the scalable controller area network controller (CAN).
MCU	39	VSSX1	Ground	VSSX1	External ground for I/O drivers. Bypass requirements depend on how heavily the MCU pins are loaded. All VSSX pins are connected together internally. Connect to Ground
MCU	40	VDDX1	Supply Input	VDDX1	External power for I/O drivers. Bypass requirements depend on how heavily the MCU pins are loaded. All VDDX pins are connected together internally. Connect to VCC and use a 100 nF bypass capacitor to ground.
MCU	41	PP3	I/O	PP3/KWP3/PWM3	Port P, I/O pin 3 is a general purpose input or output pin. It can be configured as a keypad wake-up input. It can be configured as a pulse width modulator (PWM) output channel 3.
MCU	42	PP2 PT0[8]	I/O	PP2/KWP2/PWM2 PT0[8]	Port P, I/O pin 3 is a general purpose input or output pin. It can be configured as a keypad wake-up input. It can be configured as a pulse width modulator (PWM) output channel 2.[8]
MCU	43	PP1 PT1[8]	I/O	PP1/KWP1/PWM1 PT1[8]	Port P, I/O pin 3 is a general purpose input or output pin. It can be configured as a keypad wake-up input. It can be configured as a pulse width modulator (PWM) output channel 1.[8]
MCU	44	PP0 PT2[8]	I/O	PP0/KWP0/PWM0 PT2[8]	Port P, I/O pin 3 is a general purpose input or output pin. It can be configured as a keypad wake-up input. It can be configured as a pulse width modulator (PWM) output channel 0.[8]
MCU	45	PT3	I/O	PT3/IOC3	Port T, I/O pin 3 is a general purpose input or output pin. It can be configured as a timer (TIM) channel 3.
MCU	46	VDDF	Supply	VDDF 3.3 V supply output	Signals VDDF/VSS are the secondary outputs of VREG_3V3 that provide the power supply for the NVM logic. These signals are connected to device pins to allow external decoupling capacitors (220 nF, X7R ceramic). In Shutdown mode an external supply driving VDDF/VSS can replace the voltage regulator.
MCU	47	VSS1	Ground	VSS1	See previous description for VDDF/VSS.

Notes

8. S12XEP signals noted for reuse of PC board for the calibration device.

Table 4. 912_S812 pin definitions

Analog or MCU	Pin	Pin name	Pin function	Formal name	Description and recommendations
MCU	48	PT4	I/O	PT4/IOC4/PWM4	Port T, I/O pin 4 is a general purpose input or output pin. It can be configured as a timer (TIM) channel 4 or pulse width modulator (PWM) output 4.
MCU	49	PT5	I/O	PT5/IOC5/PWM5/ API_EXTCLK	Port T, I/O pin 5 is a general purpose input or output pin. It can be configured as a timer (TIM) channel 5, pulse width modulator (PWM) output 5, or as the output of the API_EXTCLK.
MCU	50	PT6	I/O	PT6/IOC6	Port T, I/O pin 6 is a general purpose input or output pin. It can be configured as a timer (TIM) channel 6.
MCU	51	PT7	I/O	PT7/IOC7	Port T, I/O pin 7 is a general purpose input or output pin. It can be configured as a timer (TIM) channel 7.
MCU	52	BKGD	BDM	BKGD/MODC	The BKGD/MODC pin is used as a pseudo open-drain pin for the background debug communication. It is used as a MCU operating mode select pin during reset. The state of this pin is latched to the MODC bit at the rising edge of RESETB. The BKGD pin has an internal pull-up device.
MCU	53	PB0	I/O	PB0	Port B, I/O pin 0 is a general purpose input or output pin.
MCU	54	PB2	I/O	PB2	Port B, I/O pin 2 is a general purpose input or output pin.
MCU	55	PB3	I/O	PB3	Port B, I/O pin 3 is a general purpose input or output pin.
MCU	56	PB4	I/O	PB4	Port B, I/O pin 4 is a general purpose input or output pin.
MCU	57	PB5	I/O	PB5	Port B, I/O pin 5 is a general purpose input or output pin.
MCU	58	PB6	I/O	PB6	Port B, I/O pin 6 is a general purpose input or output pin.
MCU	59	PE7	I/O	PE7/ECLKX2	Port E, I/O pin 7 is a general purpose input or output pin. An internal pull-up is enabled during reset. It can be configured to output ECLKX2.
MCU	60	PE6	I/O	PE6	Port E, I/O pin 6 is a general purpose input or output pin.
MCU	61	PE4	I/O	PE4/ECLK	Port E, I/O pin 4 is a general purpose input or output pin. It can be configured to drive the internal bus clock ECLK. ECLK can be used as a timing reference. The ECLK output has a programmable prescaler.
MCU	62	VSSX2	Ground	VSSX2	External ground for I/O drivers. Bypass requirements depend on how heavily the MCU pins are loaded. All VSSX pins are connected together internally.Connect to Ground
MCU	63	VDDX2	Supply Input	VDDX2	External power for I/O drivers. Bypass requirements depend on how heavily the MCU pins are loaded. All VDDX pins are connected together internally. Connect to VCC and use a 100 nF bypass capacitor to Ground
MCU	64	RESETB	Input	RESETB External Reset Pin	The RESETB pin is an active low bidirectional control signal. It acts as an input to initialize the MCU to a known start-up state, and an output when an internal MCU function causes a reset. The RESETB pin has an internal pull-up device. Use external pull-up (10 k and 0.1 μF capacitor to Ground) connect to the 33812 RESETB pin 93.
MCU	65	VDDR	Supply Input	VDDR	Power supply input to the internal voltage regulator. Connect to VCC and use bypass capacitor, 100 nF to Ground.
MCU	66	VSS3	Ground	VSS3 Core Ground Pin	The voltage supply of nominally 1.8 V is derived from the internal voltage regulator. The return current path is through the VSS3 pin. No static external loading of these pins is permitted. Connect to Ground
MCU	67	VSSPLL	Ground	VSSPLL PLL Ground Pin	Provides operating voltage and ground for the phased-locked loop. This allows the supply voltage to the PLL to be bypassed independently. Internal power and ground are generated by the internal regulator. Connect to Ground
MCU	68	EXTAL	Clock Input	EXTAL Oscillator Pin	EXTAL is the external clock pin. On reset all the device clocks are derived from the internal reference clock. Connect to external crystal and 18 pf capacitor to Ground
MCU	69	XTAL	Clock Output	XTAL Oscillator Pin	XTAL is the crystal driver pin. On reset all the device clocks are derived from the internal reference clock. XTAL is the oscillator output. Connect to external crystal and 18 pf capacitor to Ground

Table 4. 912_S812 pin definitions

Analog or MCU	Pin	Pin name	Pin function	Formal name	Description and recommendations
MCU	70	VDDPLL	PLL Supply	Output of 3.3 V regulator	Signals VDDPLL/VSSPLL are the secondary outputs of VREG_3V3 that provide the power supply for the PLL and oscillator. These signals are connected to device pins to allow external decoupling capacitors. (100 nF...220 nF, X7R ceramic). In Shutdown mode, an external supply driving VDDPLL/VSSPLL can replace the voltage regulator.
MCU	71	IRQB	I/O	PE1/IRQB	Port E, I/O pin 1 is a general purpose input pin and the maskable interrupt request input that provides a means of applying asynchronous interrupt requests. This will wake-up the MCU from stop or wait mode.
MCU	72	XIRQB	I/O	PE0/XIRQB	Port E, I/O pin 0 is a general purpose input pin and the non-maskable interrupt request input that provides a means of applying asynchronous interrupt requests. This will wake-up the MCU from stop or wait mode. The XIRQ interrupt is level sensitive and active low. As XIRQ is level sensitive while this pin is low, the MCU will not enter STOP mode. Connect to a 10K pull-up resistor to VCC.
MCU	73	PA1	I/O	PA1	Port A, I/O pin 1 is a general purpose input or output pin.
MCU	74	PA5	I/O	PA5	Port A, I/O pin 5 is a general purpose input or output pin.
MCU	75	VDD	Supply	Output of 3.3 V regulator	Signals VDD/VSS2 are the primary outputs of VREG_3V3 that provide the power supply for the core logic.These signals are connected to device pins to allow external decoupling capacitors (220 nF, X7R ceramic).In Shutdown mode, an external supply driving VDD/VSS2 can replace the voltage regulator.
MCU	76	VSS2	Ground	Ground of 3.3 V regulator	See previous description on VDD.
MCU	77	PAD00	A/D Input	PAD00	PAD00 is the general purpose input or output pin and analog input AN0 of the analog-to-digital converter, A/D. Use voltage divider if necessary, and ESD protection capacitor. Use of low pass filter as necessary.
MCU	78	PAD01	A/D Input	PAD01	PAD01 is the general purpose input or output pin and analog input AN1 of the analog-to-digital converter, A/D. Use voltage divider if necessary, and ESD protection capacitor. Use of low pass filter as necessary.
MCU	79	PAD02	PA/D Input	PAD02	PAD02 is the general purpose input or output pin and analog input AN2 of the analog-to-digital converter, A/D. Use voltage divider if necessary, and ESD protection capacitor. Use of low pass filter as necessary.
MCU	80	PAD03	A/D Input	PAD03	PAD03 is the general purpose input or output pin and analog input AN3 of the analog-to-digital converter, A/D. Use voltage divider if necessary, and ESD protection capacitor. Use of low pass filter as necessary.
MCU	81	PAD04	A/D Input	PAD04	PAD04 is the general purpose input or output pin and analog input AN4 of the analog-to-digital converter, A/D. Use voltage divider if necessary, and ESD protection capacitor. Use of low pass filter as necessary.
MCU	82	PAD05	A/D Input	PAD05	PAD05 is the general purpose input or output pin and analog input AN5 of the analog-to-digital converter, A/D. Use voltage divider if necessary, and ESD protection capacitor. Use of low pass filter as necessary.
MCU	83	PAD06	A/D Input	PAD06	PAD06 is the general purpose input or output pin and analog input AN6 of the analog-to-digital converter, A/D. Use voltage divider if necessary, and ESD protection capacitor. Use of low pass filter as necessary.
MCU	84	PAD07	A/D Input	PAD07	PAD07 is the general purpose input or output pin and analog input AN7 of the analog-to-digital converter, A/D. Use voltage divider if necessary, and ESD protection capacitor. Use of low pass filter as necessary.
MCU	85	VDDA	Supply Input	VDDA	This is the power supply input pin for the analog-to-digital converter and the voltage regulator. Connect to VCC and use a bypass capacitor, 100 nF to Ground.
MCU	86	VRH	Supply Input	VRH	VRH and VRL are the reference voltage input pins for the analog-to-digital converter.Connect to VCC and use a bypass capacitor, 100 nF to Ground.
MCU	87	VRL	Supply Input	VRL	VRH and VRL are the reference voltage input pins for the analog-to-digital converter. Connect to Ground.
MCU	88	VSSA	Ground	VSSA	This is the ground input pin for the analog-to-digital converter and the voltage regulator. Connect to Ground.

Table 4. 912_S812 pin definitions

Analog or MCU	Pin	Pin name	Pin function	Formal name	Description and recommendations
MCU	89	PS0/RXD	I/O	PS0/ SCI RXD	Port S, I/O pin 0 is a general purpose input or output pin. It can be configured as the receive pin RXD of serial communication interface (SCI). If used for ISO9141 connect to pin 4, MRX.
MCU	90	PS1/TXD	I/O	PS1/ SCI TXD	Port S, I/O pin 1 is a general purpose input or output pin. It can be configured as the receive pin TXD of serial communication interface (SCI). If used for ISO9141 connect to pin 3, MTX.
MCU	91	TEST	Input	Test	MUST leave OPEN. leave open
MCU	92	PM5/SCK	I/O	PM5/ SPI SCK	Port M, I/O pin 5 is a general purpose input or output pin. It can be configured as the serial clock input pin for the serial peripheral interface (SPI) when the SPI is in slave mode and as a serial clock output when the SPI is in master mode.
Analog	93	RESETB	Output	RESETB Output to MCU	Logic Level ResetB signal used to reset the MCU when the watchdog circuit times out, during undervoltage condition on VCC, and for initial power up and power down. Provides RESETB to MCU on pin 64.
Analog	94	INJFLT	Output	Injector Fault	Logic Level output to MCU indicating any fault in the injector circuit.
Analog	95	RELFLT	Output	Relay Fault	Logic Level output to MCU indicating any fault in the relay circuit.
Analog	96	IGNFLT	Output	Ignition Fault	Logic Level output to MCU indicating any fault in the ignition circuit.
Analog	97	INJIN	Input	Injector Parallel Input	Logic Level Parallel Input from the MCU to control the injector driver output
Analog	98	RIN	Input	Relay Parallel Input	Logic Level Parallel input to activate RELAY output, ROUT
Analog	99	LAMPIN	Input	LAMP Parallel Input	Logic Level Parallel input to activate the malfunction indicator lamp output, LAMP
Analog	100	IGNIN	Input	Ignition Parallel Input	Logic Level Parallel Input from MCU controlling the ignition coil current flow and spark.
-	EP	GND	Ground	Substrate Ground	Should be tied to the Ground plane. Connect to Ground.

5 Electrical characteristics

5.1 Maximum ratings

Table 5. 912_S812 maximum ratings

All voltages are with respect to ground, unless otherwise noted. Exceeding these ratings may cause a malfunction or permanent damage to the device.

Symbol	Rating	Value	Unit	Notes
Electrical ratings				
V_{ESD1} V_{ESD2} V_{ESD3} V_{ESD4}	ESD Voltage • Human Body Model • Machine Model • Charge Device Model (Corner pins) • Charge Device Model	 ±2000 ±200 ±750 ±500	V	(9)
Thermal ratings				
T_A T_J T_C	Operating Temperature • Ambient • Junction • Case	 -40 to 125 -40 to 150 -40 to 125	°C	
T_{STG}	Storage Temperature	-55 to 150	°C	
P_D	Power Dissipation (T_A = 25°C)	1.7	W	(12)
T_{SOLDER}	Peak Package Reflow Temperature During Solder Mounting	Note 11	°C	(10), (11)
$R_{\theta JA}$ $R_{\theta JL}$ $R_{\theta JC}$	Thermal Resistance • Junction-to-Ambient • Junction- to-Lead • Junction-to-Flag	 75 8.0 1.2	°C/W	

Notes

9. ESD testing is performed in accordance with the Human Body Model (HBM) (C_{ZAP} = 100 pF, R_{ZAP} = 1500 Ω), the Machine Model (MM) (C_{ZAP} = 200 pF, R_{ZAP} = 0 Ω), and the Charge Device Model (CDM), Robotic (C_{ZAP} = 4.0 pF).
10. Pin soldering temperature limit is for 10 seconds maximum duration. Not designed for immersion soldering. Exceeding these limits may cause malfunction or permanent damage to the device.
11. NXP's Package Reflow capability meets Pb-free requirements for JEDEC standard J-STD-020C. For Peak Package Reflow Temperature and Moisture Sensitivity Levels (MSL), Go to www.NXP.com, search by part number [e.g. remove prefixes/suffixes and enter the core ID to view all orderable parts (i.e. MC33xxxD enter 33xxx), and review parametrics.
12. This parameter is guaranteed by design but is not production tested.

5.2 Analog MC33812 parametrics

The detailed MC33812 specifications can be found in the MC33812 data sheet. See MC33812.

5.3 Microcontroller S12XS parametrics

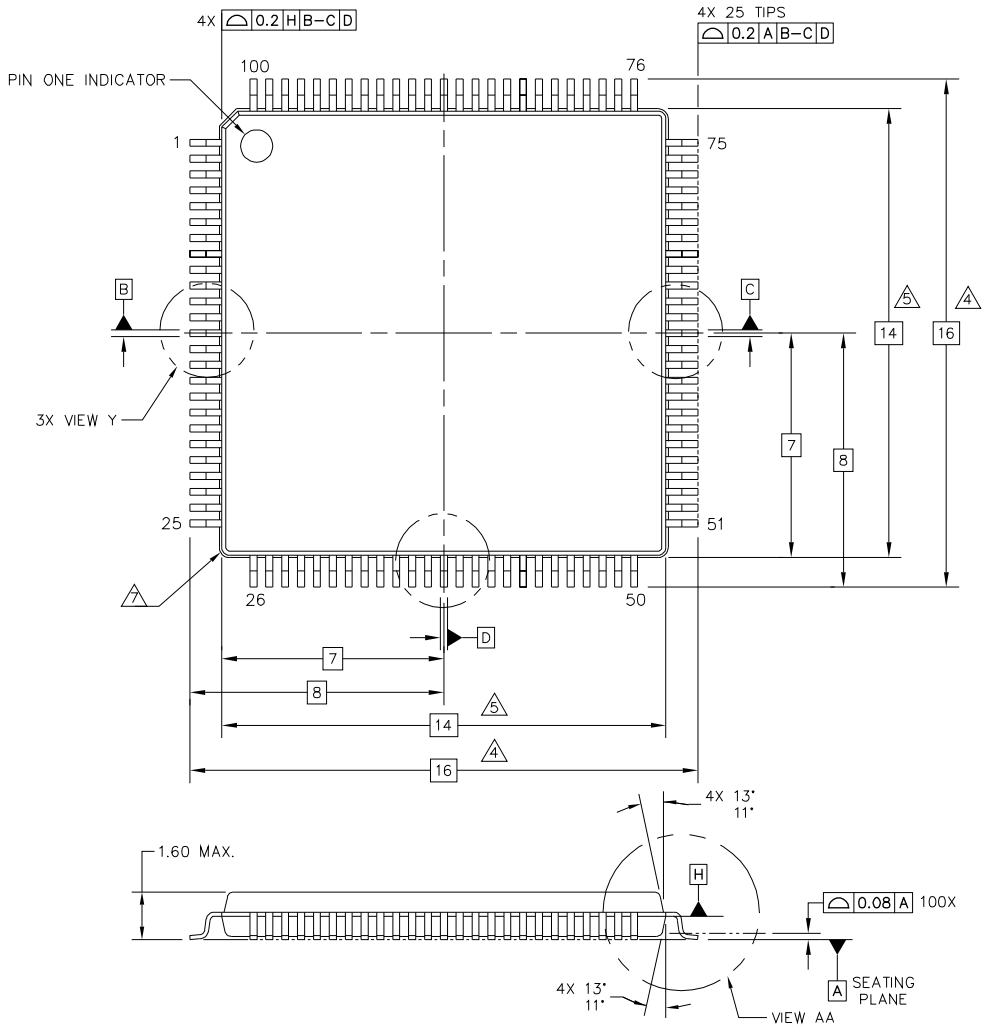
The detailed S12XS specifications can be found in the MC9S12XS128 reference manual. See MC9S12XS128.

6 Packaging

6.1 Package mechanical dimensions

Package dimensions are provided in package drawings. To find the most current package outline drawing, go to www.freescale.com and perform a keyword search for the drawing's document number.

Package	Suffix	Package outline drawing number
100-Pin LQFP-EP	AF	98ASA00371D



RELEASED FOR EXTERNAL ASSEMBLY ONLY
THIS DESIGN ONLY MEETS EXTERNAL DESIGN AND ASSEMBLY RULES. MUST BE REVIEWED AND UPDATED BEFORE BEING ASSEMBLED INTERNALLY.

MECHANICAL OUTLINE	PRINT VERSION NOT TO SCALE
TITLE: LQFP PACKAGE, 100 TERMINAL, 14X14X1.4, 0.5 PITCH EXPOSED PAD	DOCUMENT NO: 98ASA00371D REV: A
	STANDARD: NON–JEDEC
	SOT1570–1 08 JAN 2016

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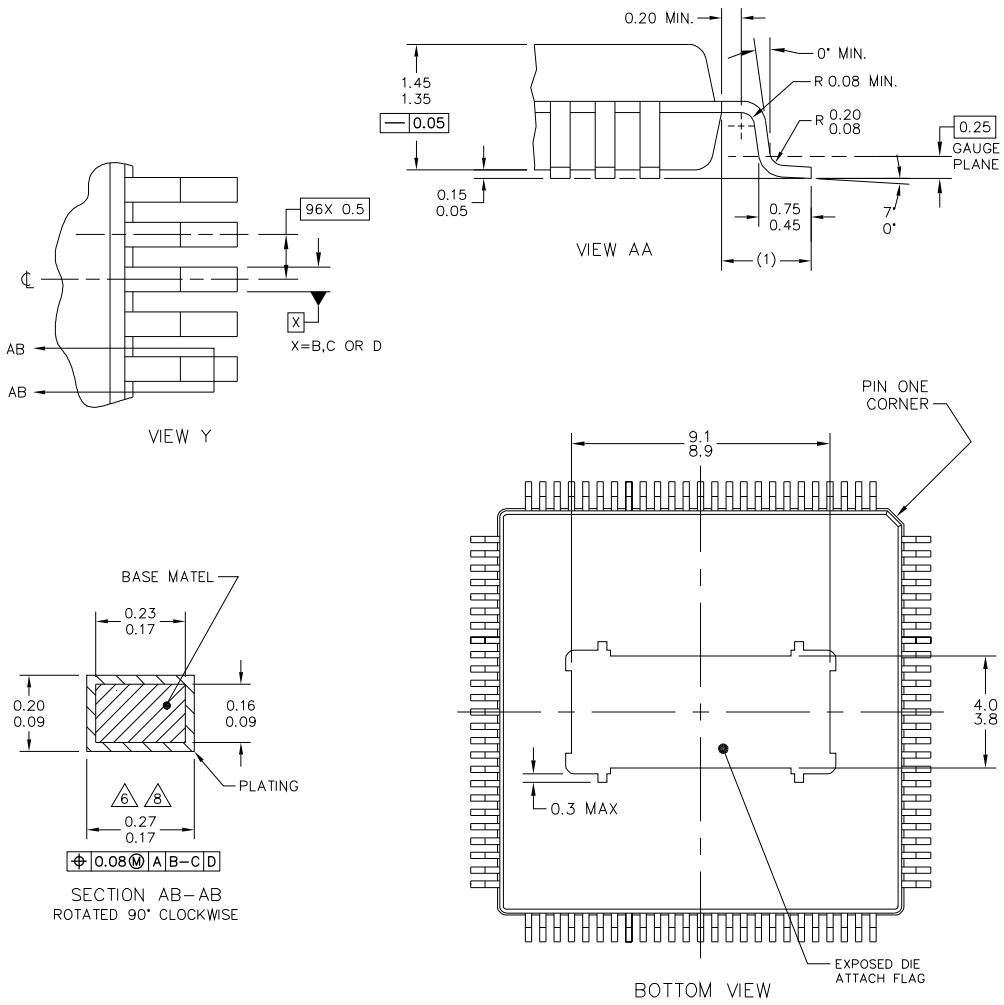

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TITLE: LQFP PACKAGE, 100 TERMINAL, 14X14X1.4, 0.5 PITCH EXPOSED PAD	DOCUMENT NO: 98ASA00371D	REV: A
	STANDARD: NON-JEDEC	
	SOT1570-1	08 JAN 2016

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NOTES:

1. DIMENSIONS AND TOLERANCING PER ASME Y14.5M–1994.
2. DIMENSIONS IN MILLIMETERS.
3. DATUMS B–C AND D TO BE DETERMINED AT DATUM PLANE H.
4. THESE DIMENSIONS TO BE DETERMINED AT SEATING PLANE, DATUM A.
5. THESE DIMENSIONS DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTRUSION IS 0.25 PER SIDE. THESE DIMENSIONS DO INCLUDE MOLD MISMATCH. THESE DIMENSIONS ARE TO BE DETERMINED AT DATUM PLANE H..
6. THIS DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED 0.35. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD OR PROTRUSION 0.07.
7. EXACT SHAPE OF EACH CORNER IS OPTIONAL.
8. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10MM AND 0.25MM FROM THE LEAD TIP.

MECHANICAL OUTLINE	PRINT VERSION NOT TO SCALE

TITLE: LQFP PACKAGE, 100 TERMINAL, 14X14X1.4, 0.5 PITCH EXPOSED PAD	DOCUMENT NO: 98ASA00371D REV: A
	STANDARD: NON–JEDEC
	SOT1570–1 08 JAN 2016

7 Revision history

Revision	Date	Description of changes
1.0	2/2013	• Initial release
2.0	2/2015	• Changed ordering part numbers from PM to MM • Updated document status to Advance Information • Update document form and style
	8/2016	• Updated to NXP document form and style

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